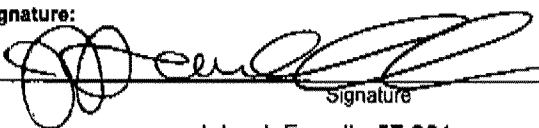


Form PTO-1595 (Rev. 03-11)
OMB No. 0851-0027 (exp. 03/31/2012)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

<p>1. Name of conveying party(ies): Micron Technology, Inc.</p> <p>Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of receiving party(ies)</p> <p>Name: <u>Round Rock Research, LLC</u></p> <p>Internal Address: _____</p> <p>Street Address: _____</p> <p>P. O. Box 1042</p> <p>City: <u>Mount Kisco</u></p> <p>State: <u>New York</u></p> <p>Country: <u>United States of America</u> Zip: <u>10549</u></p> <p>Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
<p>3. Nature of conveyance/Execution Date(s):</p> <p>Execution Date(s): <u>December 23, 2009</u></p> <p><input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name</p> <p><input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement</p> <p><input type="checkbox"/> Government Interest Assignment</p> <p><input type="checkbox"/> Executive Order 9424. Confirmatory License</p> <p><input type="checkbox"/> Other _____</p>	<p>4. Application or patent number(s): <input type="checkbox"/> This document is being filed together with a new application.</p> <p>A. Patent Application No.(s) <u>12714,130</u></p> <p>B. Patent No.(s)</p> <p>Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
<p>5. Name and address to whom correspondence concerning document should be mailed:</p> <p>Name: <u>John J. Farrell</u> <u>LERNER, DAVID, LITTENBERG,</u> <u>KRUMHOLZ & MENTLIK, LLP</u></p> <p>Internal Address: <u>Atty. Dkt.: ROUND,1370</u></p> <p>Street Address: <u>600 South Avenue West</u></p> <p>City: <u>Westfield</u></p> <p>State: <u>NJ</u> Zip: <u>07090</u></p> <p>Phone Number: <u>908-654-5000</u></p> <p>Fax Number: <u>908-654-7866</u></p> <p>Email Address: <u>ataylor@ldlkm.com</u></p>	<p>6. Total number of applications and patents involved: 1</p> <p>7. Total fee (37 CFR 1.21(h) & 3.41) \$ <u>40.00</u></p> <p><input checked="" type="checkbox"/> Authorized to be charged to deposit account</p> <p><input type="checkbox"/> Enclosed</p> <p><input type="checkbox"/> None required (government interest not affecting title)</p>
<p>8. Payment Information</p> <p>Deposit Account Number <u>12-1095</u></p> <p>Authorized User Name <u>John J. Farrell</u></p>	
<p>9. Signature:</p> <p> Signature</p> <p><u>October 28, 2011</u> Date</p> <p><u>John J. Farrell - 57,291</u> Name of Person Signing</p> <p>Total number of pages including cover sheet, attachments, and documents: 6</p>	

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EXHIBIT A**CONFIRMATORY ASSIGNMENT OF PATENT RIGHTS**

This Confirmatory Assignment of Patent Rights (the "Agreement") is entered into this 30th day of December, 2009 (the "Closing Date"), by and between Micron Technology, Inc., a Delaware corporation ("Assignor"), and Round Rock Research, LLC, a Delaware limited liability company ("Assignee").

WHEREAS, Assignor and Assignee are party to that certain Patent Sale and Transfer Agreement dated on or about the date hereof (as in effect from time to time, the "Patent Sale and Transfer Agreement"); capitalized terms used but not otherwise defined in this Agreement shall have the respective meaning assigned thereto in the Patent Sale and Transfer Agreement;

WHEREAS, pursuant to the Patent Sale and Transfer Agreement, Assignor has agreed to sell, convey, transfer, assign and deliver to Assignee all of Assignor's (and its Subsidiaries') right, title and interest, including Patent Rights, in and to the Patents listed on Schedule A hereto (collectively, the "Assigned Patents");

WHEREAS, Assignee is now desirous of acquiring the entire and exclusive right, title and interest in and to the Assigned Patents in the United States and throughout the world; and

WHEREAS, Assignor is now willing to assign to Assignee all rights, title and interest in and to the Assigned Patents in the United States and throughout the world; and

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor hereby assigns, transfers and conveys to Assignee, its successors, legal representatives and assigns, and Assignee hereby accepts, all of Assignor's right, title and interest in the United States and throughout the world in and to the Assigned Patents and any and all Letters Patent that are or may be granted thereon, and any legal equivalent thereof that may be granted in any country or countries foreign to the United States, in each case including without limitation any extensions, substitutes, continuations, continuations-in-part, divisions, reissues, reexaminations, and renewals thereof, or other equivalents thereof, and further, all rights and privileges pertaining to the Assigned Patents and any and all Letters Patent that are or may be granted thereon, and any legal equivalent thereof that may be granted in any country or countries foreign to the United States, including, without limitation, the right, if any, to petition, sue or otherwise seek and recover damages, profits and any other remedy (monetary, injunctive, declaratory or other) in the United States and anywhere throughout the world for any past, present and future infringement thereof, conversion or misappropriation of, or other injury, offense, violation, breach of duty or wrong relating to, any of the Assigned Patents, or any license, agreement, contract or other matter relating thereto.

Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States of America and the appropriate officers of all other jurisdictions in which the Assigned Patents are or may be registered or in which applications included among the Assigned Patents are pending, to record the title of Assignee, its successors, legal representatives and assigns, as owner of all right, title and interest in and to the Assigned Patents, and to issue to Assignee, its successors, legal representatives and assigns, all Letters Patent and any legal

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JOHN M DESMARAIS

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equivalent thereof that may be granted in any country or countries foreign to the United States and recordings of patent rights resulting from any application included among the Assigned Patents, in accordance with the terms of this instrument.

Except to the extent that federal law preempts state law with respect to the matters covered hereby, this Agreement shall be governed by and construed in accordance with the laws of the State of Delaware, without giving effect to any of the principles of conflicts of laws thereof that would result in the application of the laws of another jurisdiction to this Agreement.

This Agreement shall be binding on, and shall inure to the benefit of, the parties hereto and their respective successors and assigns, and may be executed in two or more counterparts, each of which shall be deemed to be an original, but all of which shall constitute one and the same agreement. Each of the parties hereto agrees to accept and be bound by facsimile signatures hereto.

Each party represents that it has taken all necessary action to authorize the execution and delivery of this Agreement.

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IN WITNESS WHEREOF, the parties hereto have caused this Agreement to be executed by their respective duly authorized officers, as of the date first written above.

ASSIGNOR:

MICRON TECHNOLOGY, INC.

By: [Signature]
Name: Steve H. Appleton
Title: Chairman and CEO

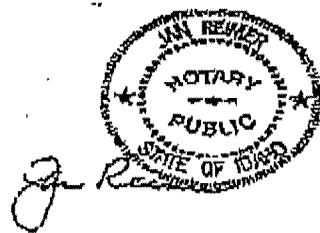
ASSIGNEE:

ROUND ROCK RESEARCH, LLC

By: [Signature]
Name: John Desmarais
Title: Manager

On this 23rd day of December 2009, before me appeared Steven R. Appleton, the person who signed this instrument, who acknowledged that he/she signed it as a free act on his/her own behalf or on behalf of the Assignor with authority to do so.

State of IDAHO)
)
) ss.
County of Ada)



[Note that federal patent assignments must also include a cover sheet, See 37 C.F.R. 5.28]

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SCHEDULE A

(to be attached)

Schedule A Patents

1994-0255.02/US	US	03-Mar-00	INDUCTOR FORMED AT LEAST PARTIALLY IN A SUBSTRATE	Issued	17-Jul-01	6262468	09/518,340
1994-0267.00/FR	FR	15-Sep-95	SPACERS FOR LARGE AREA DISPLAYS	Issued	14-Nov-97	2727241	9510857
1994-0267.00/JP	JP	15-Aug-95	SPACERS FOR LARGE AREA DISPLAYS	Issued	10-Mar-00	3042671	208120/95
1994-0267.00/KR	KR	07-Nov-95	SPACERS FOR LARGE AREA DISPLAYS	Issued	25-Mar-99	203956	95-39996
1994-0267.00/SG	SG	18-Sep-95	SPACERS FOR LARGE AREA DISPLAYS	Issued	14-Jun-97	34273	9501386-8
1994-0267.00/TW	TW	05-Jun-95	SPACERS FOR LARGE AREA DISPLAYS	Issued	01-Jul-00	117977	84105622
1994-0267.00/US	US	18-Nov-94	SPACERS FOR LARGE AREA DISPLAYS	Issued	23-Jan-96	5486126	08/349,091
1994-0267.01/US	US	15-Sep-95	FIBER SPACERS IN LARGE AREA VACUUM DISPLAYS AND METHOD FOR MANUFACTURE OF SAME	Issued	18-Aug-98	5795206	08/528,761
1994-0267.05/US	US	28-Jan-98	FIBER SPACERS IN LARGE AREA VACUUM DISPLAYS AND METHOD FOR MANUFACTURE OF SAME	Issued	06-Feb-01	6183329	09/014,642
1994-0267.06/US	US	02-Feb-01	FIBER SPACERS IN LARGE AREA VACUUM DISPLAYS AND METHOD FOR MANUFACTURE OF SAME	Issued	26-Mar-02	6361391	09/775,457
1994-0269.00/JP	JP	05-Jun-96	MEMORY ARRAY HAVING A MULTI-STATE ELEMENT AND METHOD FOR FORMING SUCH ARRAY OR CELLS THEREOF	Issued	26-Oct-01	3245174	9-501467
1994-0269.00/KR	KR	05-Dec-97	MEMORY ARRAY HAVING A MULTI-STATE ELEMENT AND METHOD FOR FORMING SUCH ARRAY OR CELLS THEREOF	Issued	09-Apr-01	0293866	97-708880
1994-0269.00/US	US	07-Jun-95	MEMORY ARRAY HAVING A MULTI-STATE ELEMENT AND METHOD FOR FORMING SUCH ARRAY OR CELLS THEREOF	Issued	09-Feb-99	5869843	08/486,639
1994-0269.01/US	US	05-Feb-99	MEMORY ARRAY HAVING A MULTI-STATE ELEMENT AND METHOD FOR FORMING SUCH ARRAY OR CELLS THEREOF	Issued	20-Jun-00	6077729	09/245,955
1994-0293.00/US	US	29-Aug-96	RADIO FREQUENCY DATA COMMUNICATION DEVICE WITH ADJUSTABLE RECEIVER SENSITIVITY	Issued	19-Oct-99	5970398	08/704,965
1994-0293.01/US	US	13-Oct-98	RADIO FREQUENCY ANTENNA WITH CURRENT CONTROLLED SENSITIVITY	Issued	19-Sep-00	6122494	09/172,714
1994-0293.02/US	US	04-Apr-00	RADIO FREQUENCY ANTENNA WITH CURRENT CONTROLLED SENSITIVITY	Issued	03-Jun-03	6574454	09/542,800
1994-0305.00/US	US	19-Dec-95	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	17-Feb-98	5719440	08/574,662
1994-0305.01/US	US	10-Oct-97	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	13-Mar-01	6201304	08/948,936
1994-0305.02/US	US	14-Jan-00	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	24-Jul-01	6265766	09/483,483
1994-0305.03/US	US	30-Oct-00	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	01-Mar-05	6861290	09/699,537
1994-0305.04/US	US	23-Jul-01	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	28-Jan-03	6512303	09/911,160
1994-0305.05/US	US	22-Nov-02	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	23-Dec-03	6667556	10/302,594
1994-0305.06/US	US	01-Mar-06	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	12-Feb-08	7329945	11/070,364
1994-0305.07/US	US	19-May-06	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Issued	03-Jun-08	7381591	11/437,550
1994-0305.08/US	US	02-Oct-07	FLIP CHIP ADAPTOR PACKAGE FOR BARE DIE	Pending			11/866,065
1994-0318.00/US	US	21-Aug-95	IMPROVED BATTERY AND CONTACT ASSEMBLY AND METHOD FOR MOUNTING A BATTERY	Issued	24-Sep-96	5558679	08/517,504
1994-0318.01/US	US	16-Jul-96	BATTERY AND CONTACT ASSEMBLY AND METHOD FOR MOUNTING A BATTERY	Issued	11-Feb-97	5601941	08/662,045
1994-0319.00/US	US	23-Oct-95	METHOD FOR ALIGNING AND ASSEMBLING SPACED COMPONENTS	Issued	03-Jun-97	5634585	08/553,798
1994-0322.00/DE	DE	08-Dec-95	METHOD AND APPARATUS FOR A HIGH SPEED CYCLICAL REDUNDANCY CHECK SYSTEM	Issued	31-Mar-99	69508800	95944609.7
1994-0322.00/GB	GB	08-Dec-95	METHOD AND APPARATUS FOR A HIGH SPEED CYCLICAL REDUNDANCY CHECK SYSTEM	Issued	31-Mar-99	630742	95944609.7